



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 10/647,297                      Group Art Unit: 1771  
Filing Date: August 26, 2003                      Examiner: Hai Vo  
Applicants: Hyun HUH et al.  
Title: Polishing Pad Containing Embedded Liquid Microelements  
and Method of Manufacturing the Same  
Attorney Docket: 47881-000003/US

Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
**Mail Stop Amendment**

May 29, 2007

**RESPONSE**

Sir:

In response to the Office Action mailed December 28, 2006, the period for response having been extended two (2) months to May 28, 2007, the following remarks are respectfully submitted in connection with the above-identified application.

**Listing of the Claims** begins on page 2 of this Amendment.

**Remarks** begin on page 8 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
<b>Total</b>	16	-	31	=	0
<b>Independent</b>	1	-	3	=	0

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